



60V N-Channel Enhancement Mode MOSFET - ESD Protected

Voltage

60 V

Current

300mA

Features

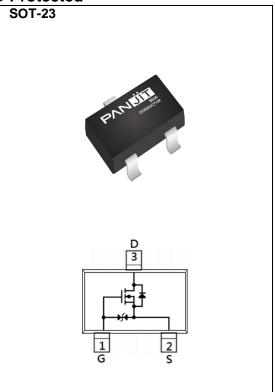
- $R_{DS(ON)}$, $V_{GS}@10V$, $I_D@500mA<3\Omega$
- $R_{DS(ON)}$, $V_{GS}@4.5V$, $I_{D}@200mA<4\Omega$
- Advanced Trench Process Technology
- High Density Cell Design For Ultra Low On-Resistance
- Very Low Leakage Current In Off Condition
- Specially Designed for Battery Operated Systems, Solid-State Relays Drivers: Relay, Displays, Memories, etc
- ESD Protected 2KV HBM
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: SOT-23 Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0084 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

| PARAMETER | | SYMBOL | LIMIT | UNITS | |
|------------------------------------------------------------------------|----------------------|----------------------------------|-------------|-------|--|
| Drain-Source Voltage | | V _{DS} | 60 | V | |
| Gate-Source Voltage | | V _G s | <u>+</u> 20 | | |
| Continuous Drain Current(Note 4) | | ID | 300 | mA | |
| Pulsed Drain Current ^(Note 1) | | I _{DM} | 2000 | | |
| Power Dissipation | T _A =25°C | P _D | 500 | mW | |
| | Derate above 25°C | | 4 | mW/°C | |
| Operating Junction and Storage Temperature Range | | T _J ,T _{STG} | -55~150 | °C | |
| Typical Thermal Resistance - Junction to Ambient ^(Note 3,4) | | ReJA | 250 | °C/W | |





Electrical Characteristics (T_A=25°C unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNITS |
|----------------------------------|---------------------|---------------------------------------------------------------------------------------------------------------|------|------|-------------|-------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V,I _D =10uA | 60 | - | - | |
| Gate Threshold Voltage | $V_{GS(th)}$ | V _{DS} =V _{GS} , I _D =250uA | 1 | - | 2.5 | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} =10V,I _D =500mA | - | - | 3 | Ω |
| | | V _{GS} =4.5V,I _D =200mA | - | - | 4 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =60V,V _{GS} =0V | - | - | 1 | uA |
| Gate-Source Leakage Current | Igss | V _{GS} = <u>+</u> 20V,V _{DS} =0V | - | - | <u>+</u> 10 | |
| Forward Transconductance | g fs | V _{DS} =15V, I _D =250mA | 100 | - | - | mS |
| Dynamic ^(Note 5) | | | | | | |
| Total Gate Charge | Q_g | V _{DS} =15V, I _D =250mA, V _{GS} =5V ^(Note 1,2) | - | 0.8 | - | nC |
| Gate-Source Charge | Q_gs | | - | 0.35 | - | |
| Gate-Drain Charge | Q_gd | | - | 0.2 | - | |
| Input Capacitance | Ciss | V _{DS} =25V, V _{GS} =0V, f=1MHZ | - | 35 | - | pF |
| Output Capacitance | Coss | | - | 13 | - | |
| Reverse Transfer Capacitance | Crss | | - | 8 | - | |
| Turn-On Delay Time | td _(on) | \/ 00\/ I 000 A | - | 2.7 | - | |
| Turn-On Rise Time | tr | $\begin{array}{l} V_{DD}{=}30V,\ I_{D}{=}200mA,\\ V_{GS}{=}10V,\\ R_{G}{=}10\Omega^{(Note\ 1,2)} \end{array}$ | - | 19 | - | ns |
| Turn-Off Delay Time | td _(off) | | - | 15 | - | |
| Turn-Off Fall Time | tf | | - | 23 | - | |
| Drain-Source Diode | | | | | | |
| Maximum Continuous Drain-Source | Is | | _ | _ | 300 | mA |
| Diode Forward Current | 15 | | _ | _ | 300 | |
| Diode Forward Voltage | V_{SD} | Is=200mA, V _{GS} =0V | - | 0.82 | 1.3 | V |

NOTES:

- 1. Pulse width < 300us, Duty cycle < 2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

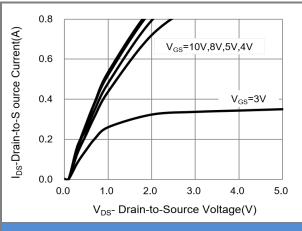


Fig.1 On-Region Characteristics

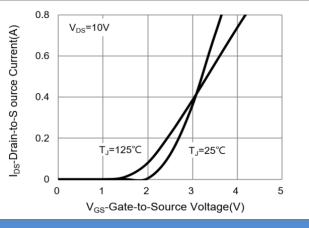


Fig.2 Transfer Characteristics

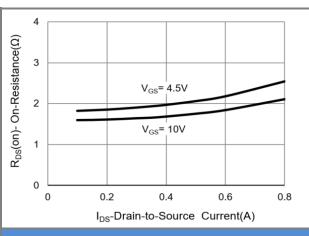


Fig.3 On-Resistance vs. Drain Current

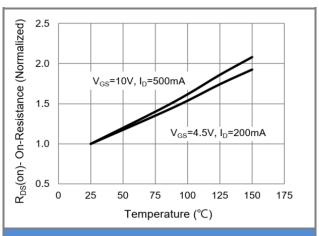


Fig.4 On-Resistance vs. Junction temperature

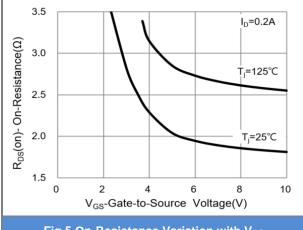
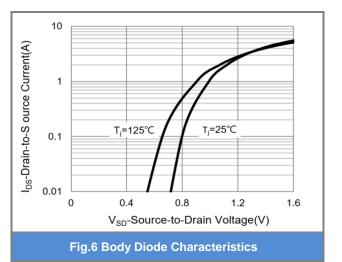


Fig.5 On-Resistance Variation with V_{GS}







TYPICAL CHARACTERISTIC CURVES

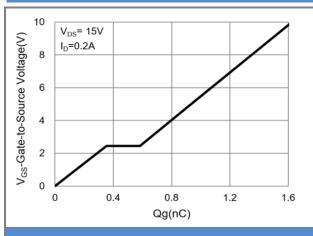


Fig.7 Gate-Charge Characteristics

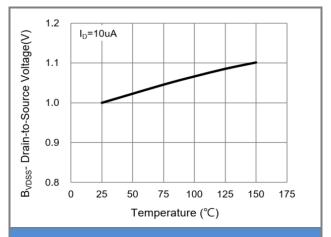


Fig.8 Breakdown Voltage Variation vs. Temperature

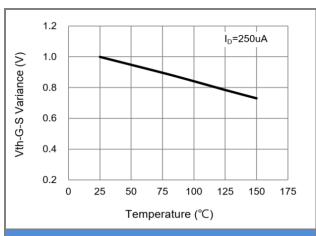


Fig.9 Threshold Voltage Variation with Temperature

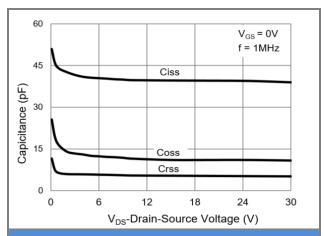


Fig.10 Capacitance vs. Drain-Source Voltage

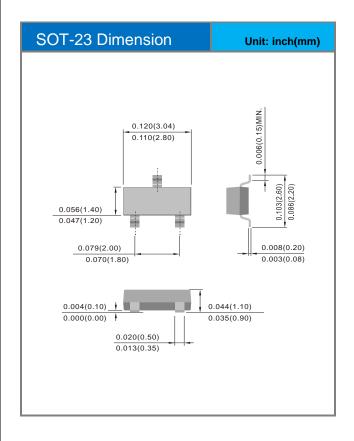


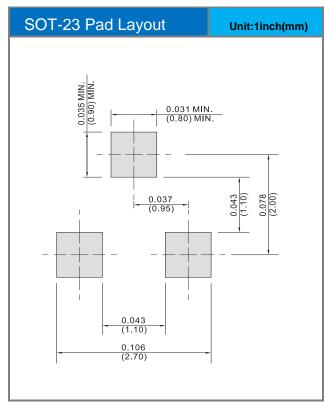


Part No. Packing Code Version

| Part No. Packing Code | Package Type | Packing Type | Marking | Version |
|-----------------------|--------------|------------------|---------|--------------------------------|
| 2N7002K_R1_00501 | SOT-23 | 3K pcs / 7" reel | K72 | Halogen free RoHS compliant |

Packaging Information & Mounting Pad Layout









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